

# NCE N-Channel Enhancement Mode Power MOSFET

## Description

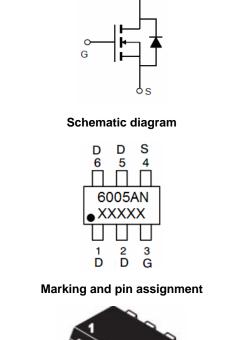
The NCE6005AN uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

### **General Features**

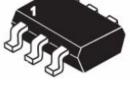
- V<sub>DS</sub>=60V,I<sub>D</sub>=5A
  R<sub>DS(ON)</sub> <35mΩ @ V<sub>GS</sub>=10V (Typ.26mΩ)
  R<sub>DS(ON)</sub> <45mΩ @ V<sub>GS</sub>=4.5V (Typ.32mΩ)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

## Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



D



SOT23-6L top view

### **Package Marking and Ordering Information**

| Device Marking | Device      | Device Package | Reel Size | Tape width | Quantity   |
|----------------|-------------|----------------|-----------|------------|------------|
| 6005AN         | NCE6005AN-S | SOT23-6L       | Ø180mm    | 8 mm       | 3000 units |

### Absolute Maximum Ratings (T<sub>A</sub>=25<sup>°</sup>Cunless otherwise noted)

| Parameter  | Symbol                           | Limit      | Unit |
|--|----------------------------------|------------|------|
| Drain-Source Voltage                             | Vds                              | 60         | V    |
| Gate-Source Voltage                              | Vgs                              | ±20        | V    |
| Drain Current-Continuous                         | Ι <sub>D</sub>                   | 5          | А    |
| Drain Current-Continuous(T <sub>C</sub> =100℃)   | I <sub>D</sub> (100℃)            | 3.5        | А    |
| Pulsed Drain Current                             | I <sub>DM</sub>                  | 24         | А    |
| Maximum Power Dissipation                        | PD                               | 2          | W    |
| Operating Junction and Storage Temperature Range | T <sub>J</sub> ,T <sub>STG</sub> | -55 To 150 | °C   |

### **Thermal Characteristic**

| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 62.5 | °C/W |
|--|-----------------|------|------|



# Electrical Characteristics (T\_A=25 $^\circ\!\!\mathrm{C}$ unless otherwise noted)

| Parameter                          | Symbol              | Condition   | Min | Тур | Max  | Unit |
|------------------------------------|---------------------|---|-----|-----|------|------|
| Off Characteristics                |                     |   |     |     |      |      |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250µA   | 60  | -   | -    | V    |
| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>    | V <sub>DS</sub> =60V,V <sub>GS</sub> =0V  | -   | -   | 1    | μA   |
| Gate-Body Leakage Current          | I <sub>GSS</sub>    | $V_{GS}$ =±20V, $V_{DS}$ =0V  | -   | -   | ±100 | nA   |
| On Characteristics (Note 3)        |                     |   | ·   |     |      |      |
| Gate Threshold Voltage             | V <sub>GS(th)</sub> | $V_{DS}=V_{GS}$ , $I_{D}=250\mu A$  | 1.2 | 1.6 | 2.5  | V    |
| Drain Source On State Desistance   | R <sub>DS(ON)</sub> | $V_{GS}$ =10V, I <sub>D</sub> =5A   | -   | 26  | 35   | mΩ   |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub> | $V_{GS}$ =4.5V, I <sub>D</sub> =5A  | -   | 32  | 45   | mΩ   |
| Forward Transconductance           | <b>g</b> fs         | V <sub>DS</sub> =5V,I <sub>D</sub> =5A  | 11  | -   | -    | S    |
| Dynamic Characteristics (Note4)    | <u>H</u>            |   | •   |     |      |      |
| Input Capacitance                  | C <sub>lss</sub>    | V <sub>DS</sub> =30V,V <sub>GS</sub> =0V,<br>F=1.0MHz                                 | -   | 979 | -    | PF   |
| Output Capacitance                 | C <sub>oss</sub>    |   | -   | 120 | -    | PF   |
| Reverse Transfer Capacitance       | C <sub>rss</sub>    |   | -   | 100 | -    | PF   |
| Switching Characteristics (Note 4) | <u>H</u>            |   | •   |     |      |      |
| Turn-on Delay Time                 | t <sub>d(on)</sub>  | V <sub>DD</sub> =30V, R <sub>L</sub> =6.7Ω<br>V <sub>GS</sub> =10V,R <sub>G</sub> =3Ω | -   | 10  | -    | nS   |
| Turn-on Rise Time                  | tr                  |   | -   | 3   | -    | nS   |
| Turn-Off Delay Time                | t <sub>d(off)</sub> |   | -   | 21  | -    | nS   |
| Turn-Off Fall Time                 | t <sub>f</sub>      |   | -   | 5   | -    | nS   |
| Total Gate Charge                  | Qg                  | V <sub>DS</sub> =30V,I <sub>D</sub> =5A,  | -   | 22  |      | nC   |
| Gate-Source Charge                 | Q <sub>gs</sub>     |   | -   | 3.3 |      | nC   |
| Gate-Drain Charge                  | Q <sub>gd</sub>     | V <sub>GS</sub> =10V  | -   | 5.2 |      | nC   |
| Drain-Source Diode Characteristics |                     |   |     |     |      |      |
| Diode Forward Voltage (Note 3)     | V <sub>SD</sub>     | V <sub>GS</sub> =0V,I <sub>S</sub> =5A  | -   |     | 1.2  | V    |
| Diode Forward Current (Note 2)     | Is                  |   | -   | -   | 5    | Α    |

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

**2.** Surface Mounted on FR4 Board, t  $\leq$  10 sec.

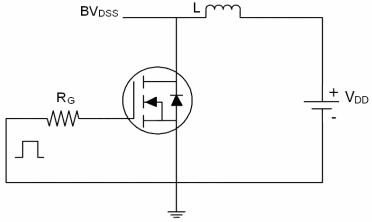
**3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

4. Guaranteed by design, not subject to production

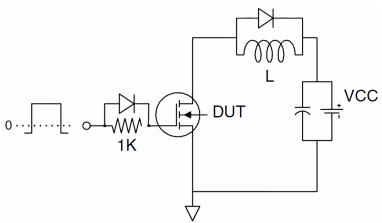
5. EAS condition:Tj=25  $^\circ C$ ,VDD=30V,VG=10V,L=0.5mH,Rg=25 $\Omega$ 



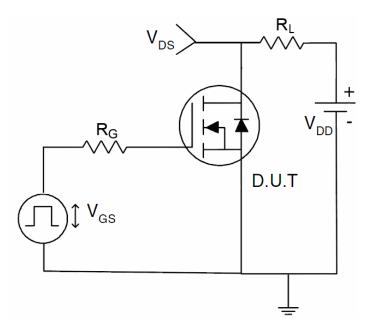
# Test Circuit 1) E<sub>AS</sub> test Circuit



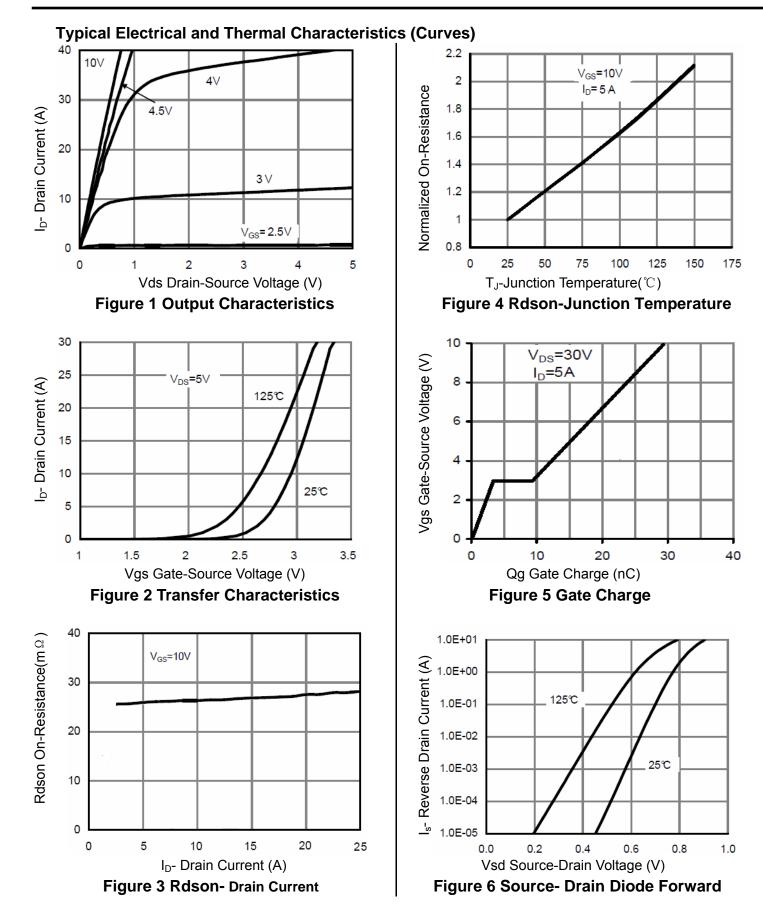
# 2) Gate charge test Circuit



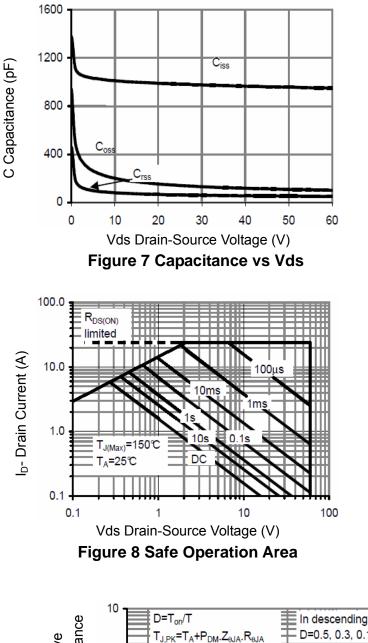
3) Switch Time Test Circuit











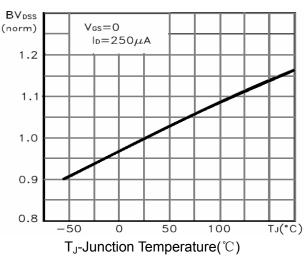


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

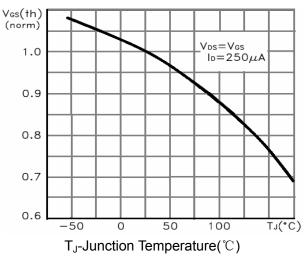
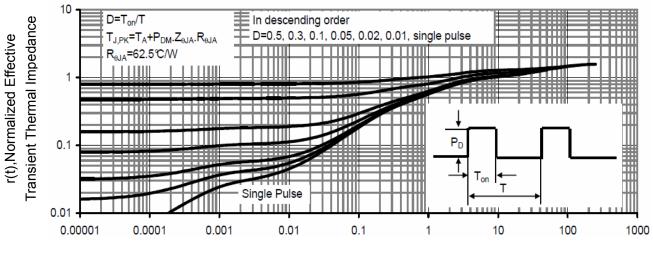


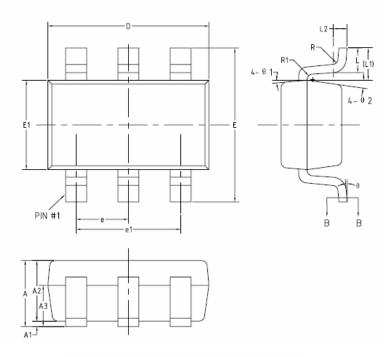
Figure 10 V<sub>GS(th)</sub> vs Junction Temperature



Square Wave Pluse Duration (sec) Figure 11 Normalized Maximum Transient Thermal Impedance

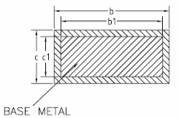


# SOT23-6L Package Information



#### COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

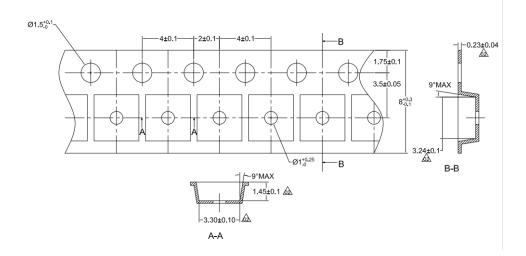
| MIN     | NOM  | MAX   |  |
|---------|------|---|--|
| -       | -    | 1.45  |  |
| 0       | —    | 0.15  |  |
| 0.90    | 1.10 | 1.30  |  |
| 0.60    | 0.65 | 0.70  |  |
| 0.39    | _    | 0.49  |  |
| 0.38    | 0.40 | 0.45  |  |
| 0.12    | -    | 0.19  |  |
| 0.11    | 0.13 | 0.15  |  |
| 2.85    | 2.95 | 3.05  |  |
| 2.60    | 2.80 | 3.00  |  |
| 1.55    | 1.65 | 1.75  |  |
| 0.85    | 0.95 | 1.05  |  |
| 1.80    | 1.90 | 2.00  |  |
| 0.35    | 0.45 | 0.60  |  |
| 0.59REF |      |   |  |
| 0.25BSC |      |   |  |
| 0.05    | -    | -   |  |
| 0.05    | -    | 0.20  |  |
| 0*      | -    | 8*  |  |
| 8*      | 10°  | 12*   |  |
| 8'      | 10°  | 12*   |  |
|         |      | −      −        0      −        0.90      1.10        0.60      0.65        0.39      −        0.38      0.40        0.12      −        0.11      0.13        2.85      2.95        2.60      2.80        1.55      1.65        0.85      0.95        1.80      1.90        0.35      0.45        0.59REF      0.25BSC        0.05      −        0.05      −        0.7      −        8*      10* |  |

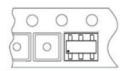






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